

Customer Code: _____

DATASHEET

DAPU P/N: DPZ3212M000050AA

DAPU			Customer Approval
Drew	Audited	Approved	Stamp, please! Thanks!
Jack	David	William	
Date: 2022.11.25			

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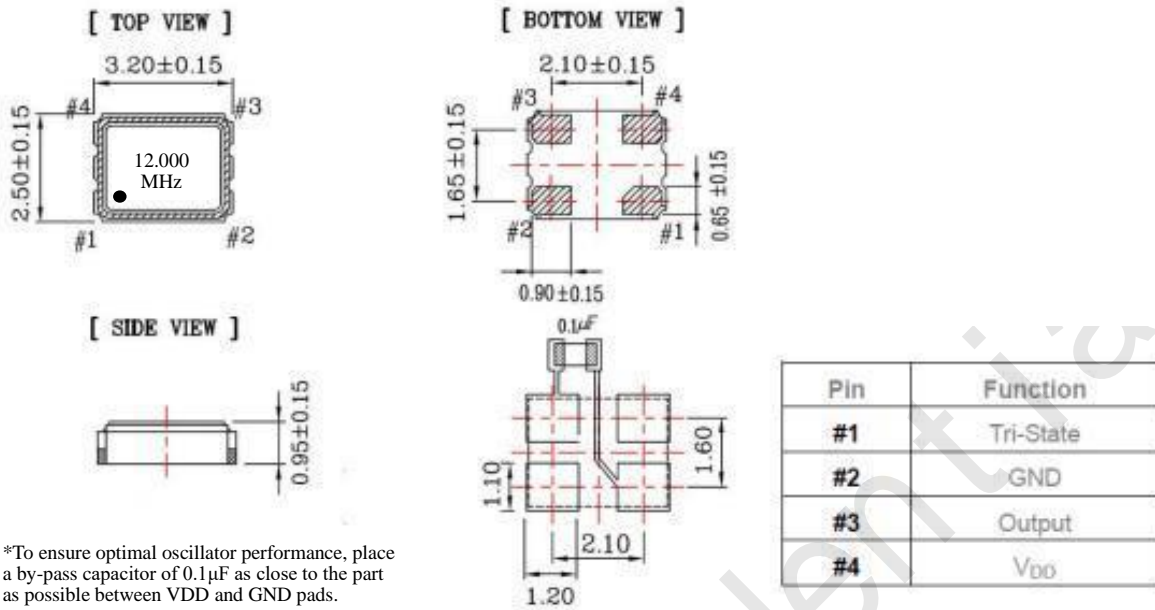


1、 Electrical Parameters

MODEL: DPZ3212M000050AA							
For Automotive							
No.	Parameters	SYM.	Electrical Spec.				Notes
			Min.	Typ.	Max.	Units	
1	Standard	-	Conforms to AEC-Q200				
2	Nominal Frequency	FL	12.00			MHz	
3	Frequency Tolerance	-	-10		+ 10	$\times 10^{-6}$	At 25°C
4	Frequency Stability	-	-50		+ 50	$\times 10^{-6}$	Over Operating Temperature Range
5	Operating Temperature	Topr	-40	~	+ 125	°C	
6	Storage Temperature	Tstg	-55	~	+ 125	°C	
7	Supply Voltage	V _{DD}	4.5	5.0	5.5	V	V _{DD} ±10%
8	Input Current	I _{cc}			15	mA	No load condition
9	Output waveform	-	CMOS				
10	Output Load	CL	15			pF	
11	Output Voltage High	V _{OH}	90%			V _{DD}	
12	Output Voltage Low	V _{OL}			10%	V _{DD}	
13	Rise/Fall Time	T _r 、 T _f			5	ns	10%-90% V _{DD} Level
14	Aging	-	-3		+ 3	$\times 10^{-6}$	First Year at 25°C
15	Tri-State Output Enable	-	70%			V _{DD}	Pin 1, OE
16	Tri-State Output Disable	-			30%	V _{DD}	Pin 1, OE
17	Duty Cycle	-	45	~	55	%	
18	Start-Up Time	T _{start}			2	ms	Measured from the time V _{DD} reaches its rated minimum value

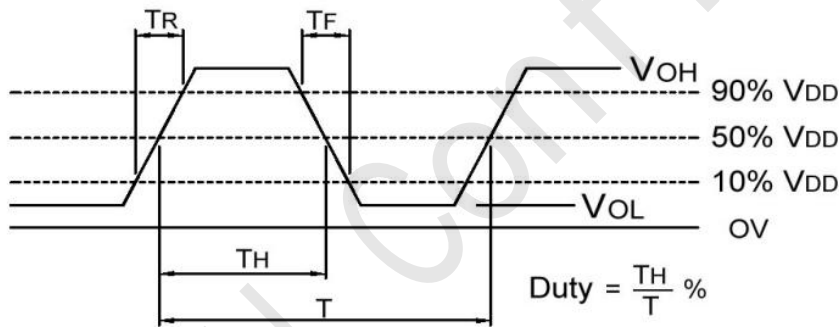


2、 Mechanical Structure(mm)

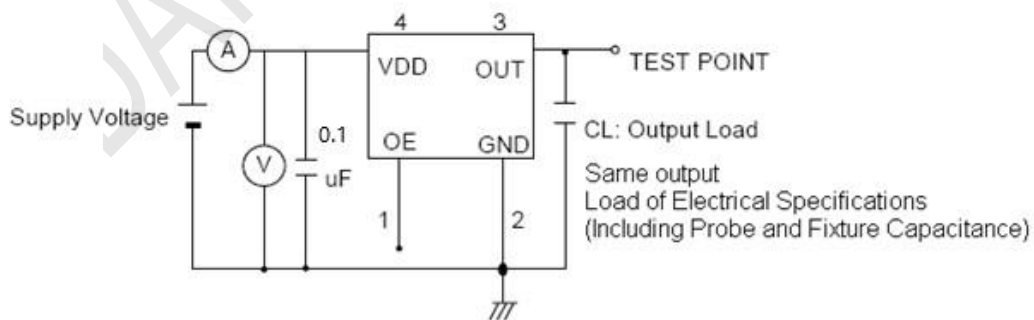


*To ensure optimal oscillator performance, place a by-pass capacitor of 0.1µF as close to the part as possible between VDD and GND pads.

3、 Output Waveform



4、 Test Circuit



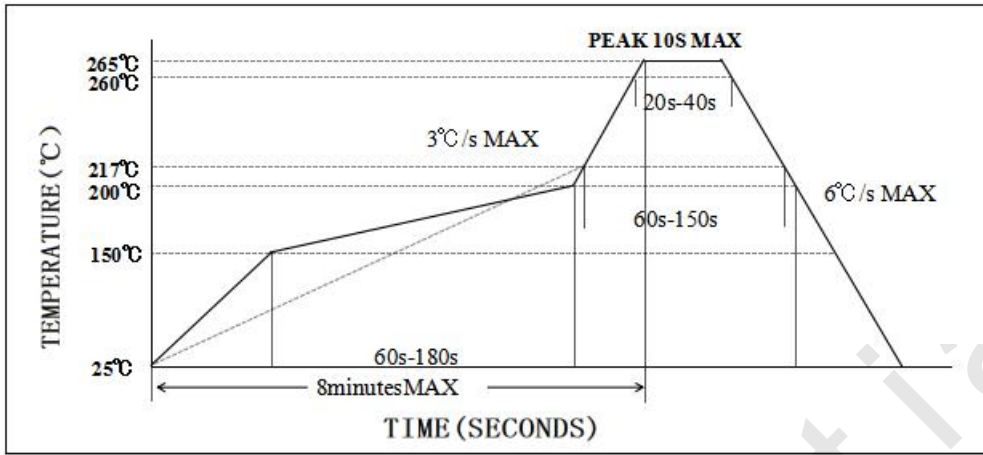
Control input (output enable/disable)

Logic 1 or open on pad 1: Oscillator output

Logic 0 on pad 1 : Disable output to high impedance



5、 Reflow Soldering Curve (RoHS)



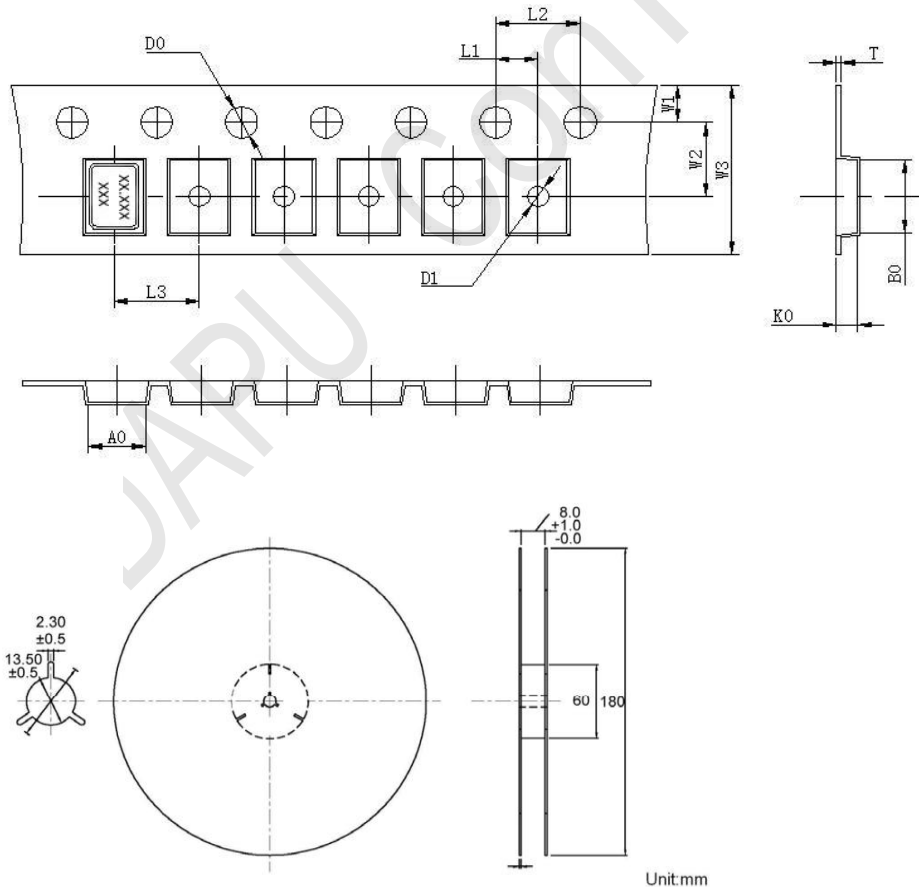
6、 Electro-static Discharges

HBM: Class3A

MM: ClassC

CDM: ClassIV

7、 Package: Tape & Reel (mm)

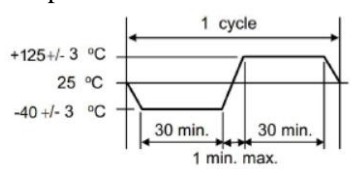


L1	2.00 ± 0.1
L2	4.00 ± 0.1
L3	4.00 ± 0.1
D0	1.55 ± 0.05
D1	1.20 ± 0.5
W1	1.75 ± 0.1
W2	3.50 ± 0.1
W3	8.00 ± 0.2
A0	2.7 ± 0.1
B0	3.4 ± 0.1
K0	1.40 ± 0.1
T	0.25 ± 0.05



8、Reliability Test Specification

6.1 Reliability Test

NO.	Test Items	Test Standard	Test Condition	Standard
1	High temperature storage	MIL-STD-202 Method 108	The crystal was placed at a temperature of $125^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for 1000 hours.	A
2	Temperature cycle	JESD22 Method JA-104	Crystal do 1000 cycles according to the table below temperature. 	A
3	Temperature and humidity	MIL-STD-202 Method 103	The crystal is placed for 1000 hours at a temperature of $85^{\circ}\text{C} \pm 2^{\circ}\text{C}$ and a humidity of 85% Time.	A
4	Life span	MIL-STD-202 Method 108	The crystal is placed at a temperature of $105^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for 1000 hours (applied rated VDD).	A
5	shock	MIL-STD-202 Method 213	shock method:half sine wave 100G Duration:6ms Direction:X, Y, Z Axial, 6 faces, 18 shocks in total.	A
6	Vibration	MIL-STD-202 Method 204	Vibration frequency:10~2000Hz Vibration amplitude:1.5mm Scan time:20 min Directions:X, Y, Z (12 cycles in each of the three directions)	A
7	Resistance to soldering heat	MIL-STD-202 Method 210	Reflow soldering: Peak temperature: $260 \pm 5^{\circ}\text{C}$, time: $10\text{s} \pm 1\text{s}$.	A
8	Solderability	J-STD-002	Soldering temperature: $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Immersion time:5 seconds ± 0.5 seconds Flux:Rosin Resin Methanol Solvent (1 : 4)	B

6.2 Test judgment

Specification	
A	Test after 24 ± 2 hours under normal temperature and normal humidity, and meet Electrical performance requirements.
B	At least 95% of the immersed end is covered with new welding material.